

SENSITIVE GATE TRIACS

FEATURES

■ VERY LOW I_{GT} = 10mA max

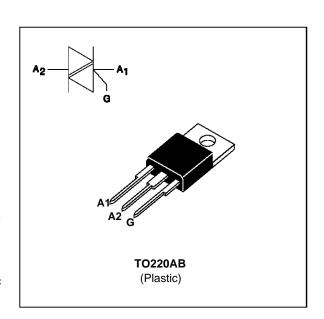
■ LOW I_H = 25mA max

■ BTA Family: INSULATING VOLTAGE = 2500V_(RMS) (UL RECOGNIZED: E81734)

DESCRIPTION

The BTA/BTB08 S/A triac family are high performance glass passivated PNPN devices.

These parts are suitables for general purpose applications where gate high sensitivity is required. Application on 4Q such as phase control and static switching.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit		
IT(RMS)	RMS on-state current BTA		Tc = 75°C	8	Α
	(360° conduction angle)	втв	Tc = 80°C		
ITSM				84	Α
	(Tj initial = 25°C)		tp = 10 ms	80	
l ² t	l ² t value	tp = 10 ms	32	A2s	
dl/dt			Repetitive F = 50 Hz	10	A/μs
		50			
Tstg Tj	Storage and operating junction temperature range			- 40 to + 150 - 40 to + 110	ိ ပိ
TI	Maximum lead temperature for soldering during 10 s at 4.5 mm from case			260	°C

Symbol	Parameter	BTA / BTB08- 400 S/A 600 S/A 700 S/A 400 600 700			
		400 S/A	600 S/A	700 S/A	
VDRM VRRM	Repetitive peak off-state voltage Tj = 110°C	400	600	700	V

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THERMAL RESISTANCES

Symbol	Parameter	Value	Unit	
Rth (j-a)	Junction to ambient	60	°C/W	
Rth (j-c) DC	Junction to case for DC BTA		4.4	°C/W
		втв	3.2	
Rth (j-c) AC	Junction to case for 360° conduction angle (F= 50 Hz)	вта	3.3	°C/W
	(F= 50 Hz)		2.4	

GATE CHARACTERISTICS (maximum values)

 $P_{GM} = 10W$ (tp = 20 μ s) $I_{GM} = 4A$ (tp = 20 μ s) $V_{GM} = 16V$ (tp = 20 μ s).

ELECTRICAL CHARACTERISTICS

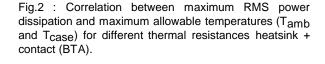
Symbol	Test Conditions		Quadrant	adrant		Suffix	
					S	Α	
IGT	$V_D=12V$ (DC) $R_L=33\Omega$	Tj=25°C	1-11-111	MAX	10	10	mA
			IV	MAX	10	25	
VGT	V _D =12V (DC) R _L =33Ω	Tj=25°C	I-II-III-IV	MAX	1.	.5	V
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	Tj=110°C	I-II-III-IV	MIN	0	.2	V
tgt	$V_D=V_{DRM}$ $I_G=40$ mA $dI_G/dt=0.5$ A/ μ s	Tj=25°C	I-II-III-I∨	TYP	2	2	μs
IL	IG= 1.2 I _{GT}	Tj=25°C	I-III-IV	TYP	20	20	mA
			II		40	40	
IH *	IT= 100mA gate open	Tj=25°C		MAX	25	25	mA
V _{TM} *	I _{TM} = 11A tp= 380µs	Tj=25°C		MAX	1.	75	V
IDRM	VDRM Rated	Tj=25°C		MAX	0.	01	mA
IRRM	V _{RRM} Rated	Tj=110°C		MAX	0.	75	
dV/dt *	Linear slope up to V _D =67%V _{DRM} gate open	Tj=110°C		MIN	10	10	V/μs
(dV/dt)c *	(dl/dt)c= 3.5A/ms	Tj=110°C		TYP	5	5	V/μs

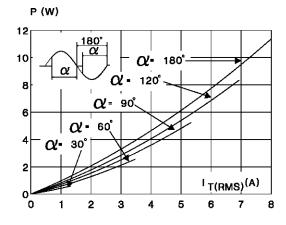
 $^{^{\}star}$ For either polarity of electrode A_2 voltage with reference to electrode A_1 .

ORDERING INFORMATION

Package	IT(RMS)	V _{DRM} / V _{RRM}	Sensitivity S	Specification
	Α	V	S	Α
ВТА	8	400	X	X
(Insulated)		600	Х	Х
		700	Х	Х
ВТВ		400	Х	X
(Uninsulated)		600	Х	Х
		700	Х	Х

Fig.1: Maximum RMS power dissipation versus RMS on-state current (F=50Hz). (curves are cut off by (dl/dt)c limitation)

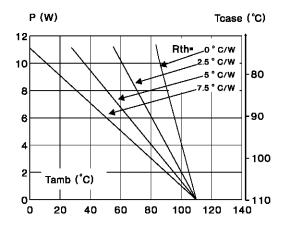




P (W) Tcase (°C) 12 Rth-_o°c/w 2.5 ° C/W 10 5 ° C/W -80 7.5 ° C/W 8 -90 100 Tamb (°C) 110 o 20 40 60 80 100 120 140

Fig.3 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (BTB).

Fig.4: RMS on-state current versus case temperature.



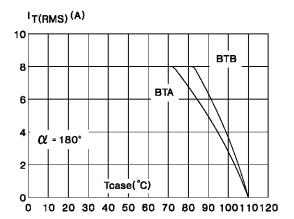


Fig.5: Relative variation of thermal impedance versus pulse duration.

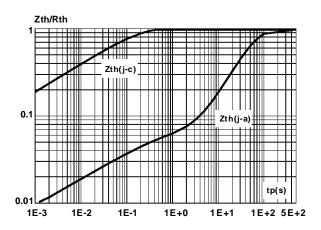


Fig.7 : Non Repetitive surge peak on-state current versus number of cycles.

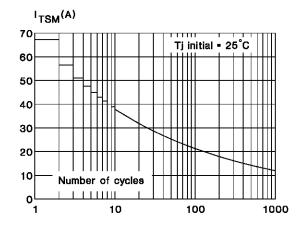


Fig.9: On-state characteristics (maximum values).

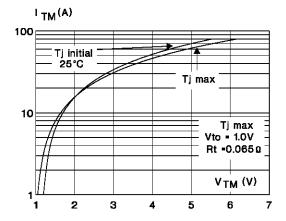


Fig.6: Relative variation of gate trigger current and holding current versus junction temperature.

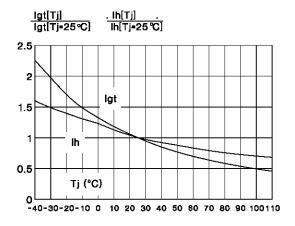
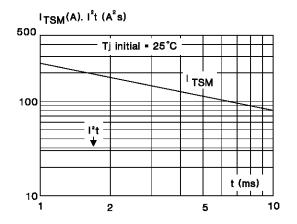
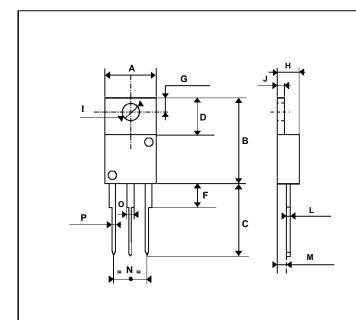


Fig.8 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \le 10 ms$, and corresponding value of l^2t .



PACKAGE MECHANICAL DATA

TO220AB Plastic



REF.	DIMENSIONS				
	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
Α	10.20	10.50	0.401	0.413	
В	14.23	15.87	0.560	0.625	
С	12.70	14.70	0.500	0.579	
D	5.85	6.85	0.230	0.270	
F		4.50		0.178	
G	2.54	3.00	0.100	0.119	
Н	4.48	4.82	0.176	0.190	
I	3.55	4.00	0.140	0.158	
J	1.15	1.39	0.045	0.055	
L	0.35	0.65	0.013	0.026	
М	2.10	2.70	0.082	0.107	
N	4.58	5.58	0.18	0.22	
0	0.80	1.20	0.031	0.048	
Р	0.64	0.96	0.025	0.038	

Cooling method: C Marking: type number Weight: 2.3 g

Recommended torque value : 0.8 m.N. Maximum torque value : 1 m.N.

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